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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

JCS29 U.S. PTO
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Applicant : BARBARA VASQUEZ ET AL.

Filed : CONCURRENTLY HEREWITH

Title : METHOD OF APPLYING A BOTTOM SURFACE PROTECTIVE COATING TO A WAFER, AND WAFER DICING METHOD

INFORMATION DISCLOSURE STATEMENT

Hon. Commissioner of Patents and Trademarks,
Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

U.S. Patent 6,023,094 (Kao et al.), dated February 8, 2000.

Respectfully submitted,


For Applicants

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Date: January 31, 2002

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